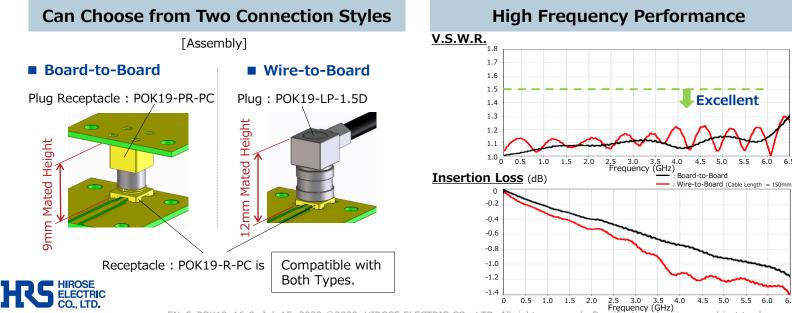
## FLYER **POK19** Series

## 9mm/12mm Mated Height **RF Board-to-Board/Wire-to-Board Connector for Automotive**



	Features	<ol> <li>Low profile RF Connector         <ul> <li>Board-to-Board : 9mm Mated Height</li> <li>Wire-to-Board : 12mm Mated Height</li> </ul> </li> <li>Choice of two connection methods improves board design flexibility</li> <li>Mating failure minimized with clear tactile click</li> </ol>	Automotive
		4 Excellent high frequency performance - V.S.W.R. : 1.5 Max. (0 to 6GHz)	
		5 Meets severe automotive requirements	
		6 Suitable for Automotive applications such as Infotainment, Telematics, Camera and Antenna	



## **Specifications**

6 '

6.5

Characteristic Impedance	50Ω
V.S.W.R.	0 to 6GHz : 1.5 Max.
Operating Temperature	-40 to +105°C*
Contact Resistance	Inner/Outer contact $30m\Omega$ Max. at $1mA$ AC
Withstanding Voltage	500V AC for 1 min.
Insulation Resistance	100MΩ Min. (500V DC)
Mating Durability	30 times
Shock Resistance	980m/s <sup>2</sup> , 6ms pulse duration 10 times in 3 directions

\*Includes the temperature rise due to current flow.

- Applicable Cable : 1.5DS (Outer diameter : ø3.0)

Specifications therein are subject to change without notice. Contact Hirose for the latest specifications, drawings, and availabilities. EN\_F\_POK19\_16-9, Jul. 15, 2020 ©2020 HIROSE ELECTRIC CO., LTD. All rights reserved.